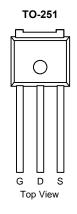


P-Channel 60 V (D-S) MOSFET

V _{DS}		-60	V
R _D S(on),typ	V _{GS} =10V	48	mΩ
RDS(on),typ	VGS=4.5V	57	mΩ
ID		-30	Α



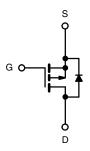
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $(T_A = 2)$	25 °C, unless otherw	vise note)			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS} ± 20		v	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I-	- 30		
Continuous Drain Current (1) = 130 C)	T _C = 125 °C	l _D	- 20	^	
Pulsed Drain Current	<u>'</u>		- 100	Α	
Avalanche Current, Single Pulse	L = 0.1 mH	I _{AS}	- 22		
Repetitive Avalanche Energy, Single Pulse ^a	L = 0.1 min	E _{AS}	24.2	mJ	
Device Discinction	T _C = 25 °C	P _D 38.5 ^c		14/	
Power Dissipation	T _A = 25 °C		2.3 ^{b, c}	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian un lumation to Anchionab	t ≤ 10 s	R _{thJA}	17	21		
Maximum Junction-to-Ambient ^D	Steady State	' 'thJA	45	55	°C/W	
Maximum Junction-to-Case		R _{thJC}	2.7	3.25		

Notes:

- a. Duty cycle \leq 1 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.
- d. Based up on T_C = 25 °C.



Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ} \text{ C}$			- 125		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α	
		V _{GS} = - 10 V, I _D = - 10 A			48		
	B	V _{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C			100	mΩ	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = -10 \text{ A}, T_J = 150 ^{\circ}\text{C}$			120		
		V _{GS} = - 4.5 V, I _D = - 5 A			57	S	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S	
Dynamic ^b							
Input Capacitance	C _{iss}				1900	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$			130		
Reverse Transfer Capacitance	C _{rss}				90		
Total Gate Charge ^c	Q_g			26		nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$		4.5			
Gate-Drain Charge ^c	Q _{gd}			7			
Gate Resistance	R _g	f = 1 MHz		7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_L = 3 \Omega$		9	15	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -19 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 2.5 \Omega$		65	100		
Fall Time ^c	t _f			30	45		
Drain-Source Body Diode and Charact	eristics (T _C = 2	5 °C) ^b		,			
Continuous Current	Is				- 30		
Pulsed Current	I _{SM}				- 30	Α	
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns	

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

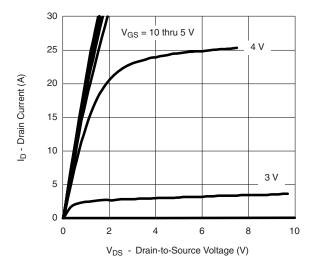


55 °C

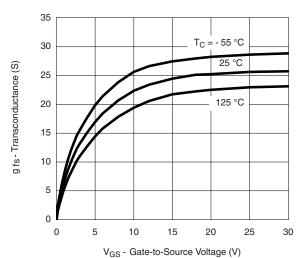
4.0

3.5

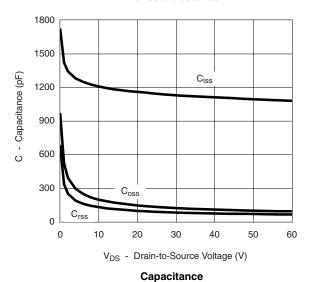
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics



Transconductance



25 (Y) 20 15 15 T_C = 125 °C

30

5

0

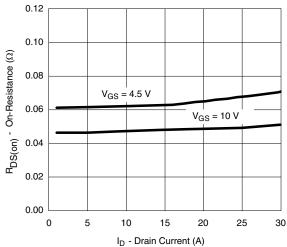
0.0 0.5

V_{GS} - Gate-to-Source Voltage (V)

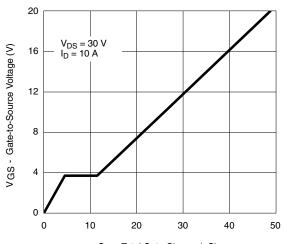
1.0 1.5 2.0 2.5 3.0

25 °C

Transfer Characteristics



On-Resistance vs. Drain Current

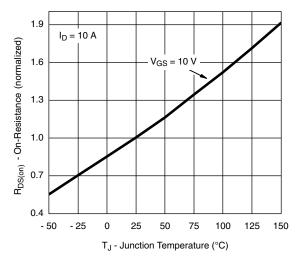


 $\mathbf{Q}_{\mathbf{g}}\,$ - Total Gate Charge (nC)

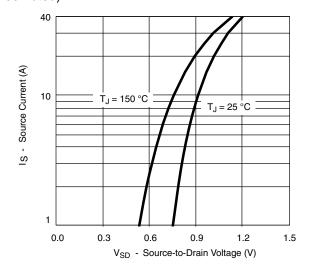
Gate Charge



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

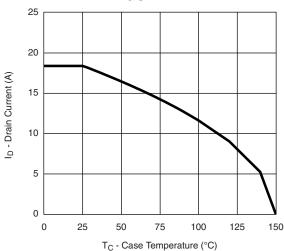


On-Resistance vs. Junction Temperature

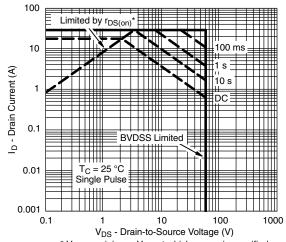


Source-Drain Diode Forward Voltage

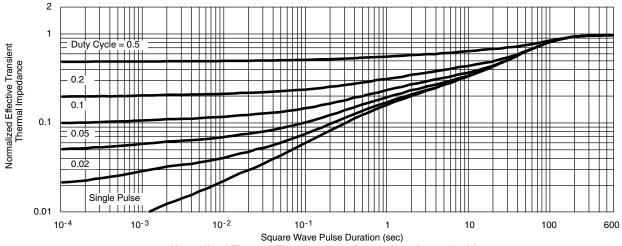
THERMAL RATINGS



Maximum Drain Current vs. Case Temperature



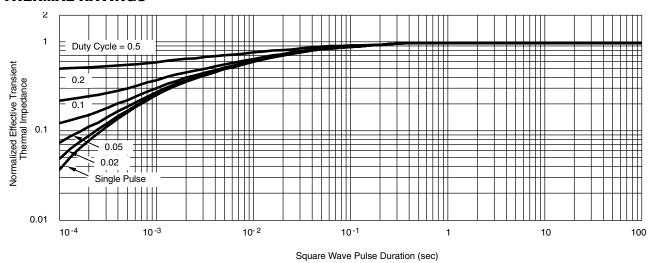
* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Ambient



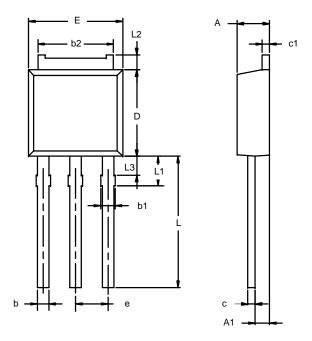
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA



Note: Dimension L3 is for reference only.

	MILLIN	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A 1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
с1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28	2.28 BSC		BSC
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060



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